

LINEAR TECHNOLOGY MATERIALS DECLARATION

ltc1440cn8#pbf

(Engineering Calculation)

PDIP

(printed on: 2020-07-11 17:26:11)

TOTAL MASS (g) : 0.497961

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001358	1000000	2727.11962891		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000076	1000000	152.622299194		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.149760	975000	300746.25		
		Iron (Fe)	7439-89-6	0.003686	24000	7402.18164062		
		Phosphorus (P)	7723-14-0	0.000046	300	92.376663208		
		Zinc (Zn)	7440-66-6	0.000108	700	216.884338379		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.153600	1000000	308457.71875		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.012410	1000000	24922.1992188		
		External Plating Total:				0.012410	1000000	24922.1992188
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.001228	1000000	2466.05541992		
Internal Plating Total:				0.001228	1000000	2466.05541992		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000533	750000	1070.36425781		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000178	250000	357.457519531		
Die Attach Total:				0.000711	1000000	1427.82177734		
Encapsulation	FILLED EPOXY RESIN	Resin (EP)		0.078790	240000	158225.15625		
		Bromine (Br)	40039-93-8	0.003283	10000	6592.88232422		
		Silica (SiO2)	60676-86-0	0.236370	720000	474675.4375		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.009849	30000	19778.6464844		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000000	0	0		
		Encapsulation Total:				0.328292	1000000	659272.125
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000286	1000000	574.34185791		
					TOTAL MASS (g) :	0.497961		